

D²PAK HV



DPAK HV



**STBR series 1200 & 800 V
automotive & industrial
grade bridge diodes**

ST Bridge Rectifier

STBR 800 & 1200 V bridge rectifiers

For input bridge, bypass, reverse battery protection, O-ring, etc.

Markets



Automotive



Industrial

Applications

OBC

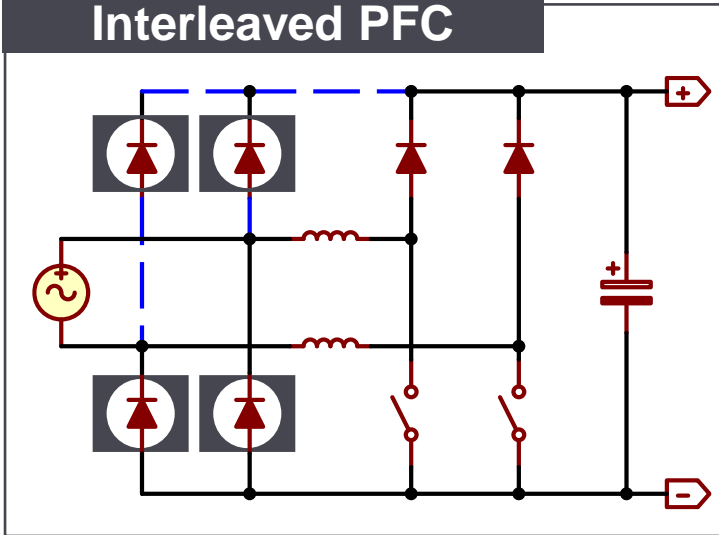


EV chargers



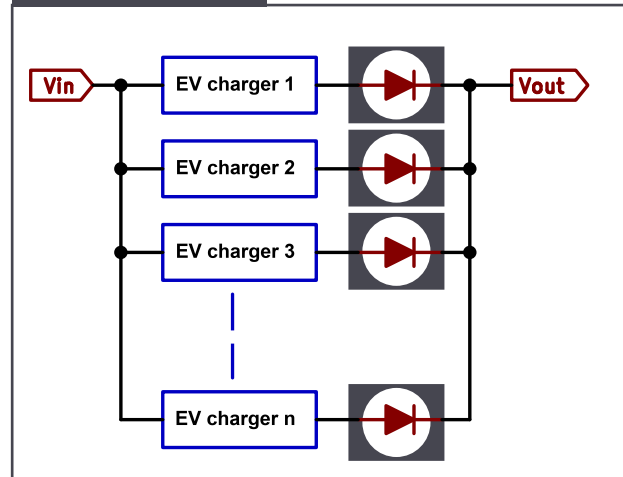
STBR series for low conduction power losses

Semi-bridgeless & Interleaved PFC

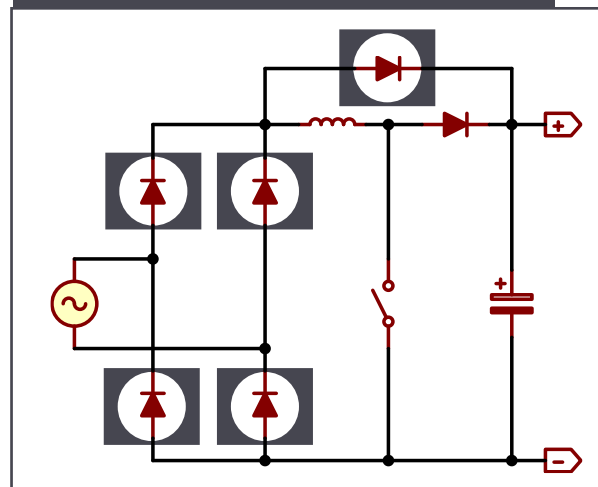


STBR diode

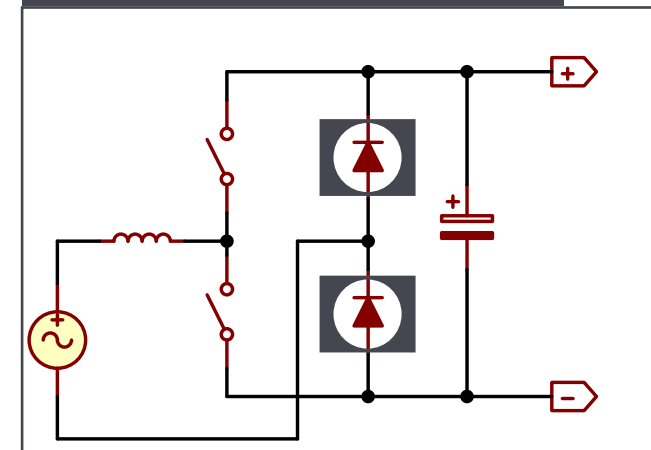
O-ring



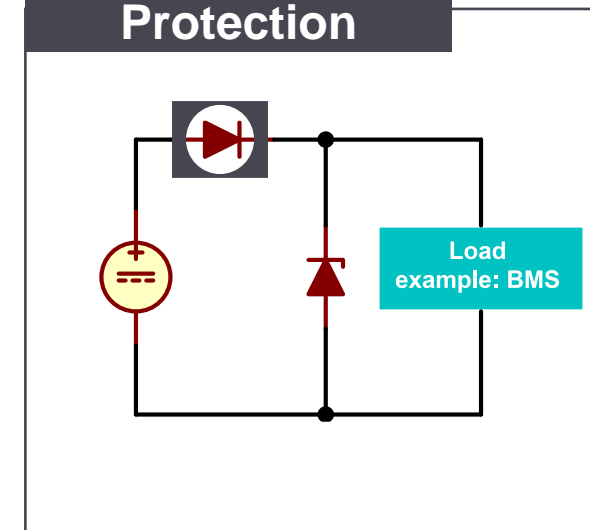
Input bridge / Bypass



Totem pole

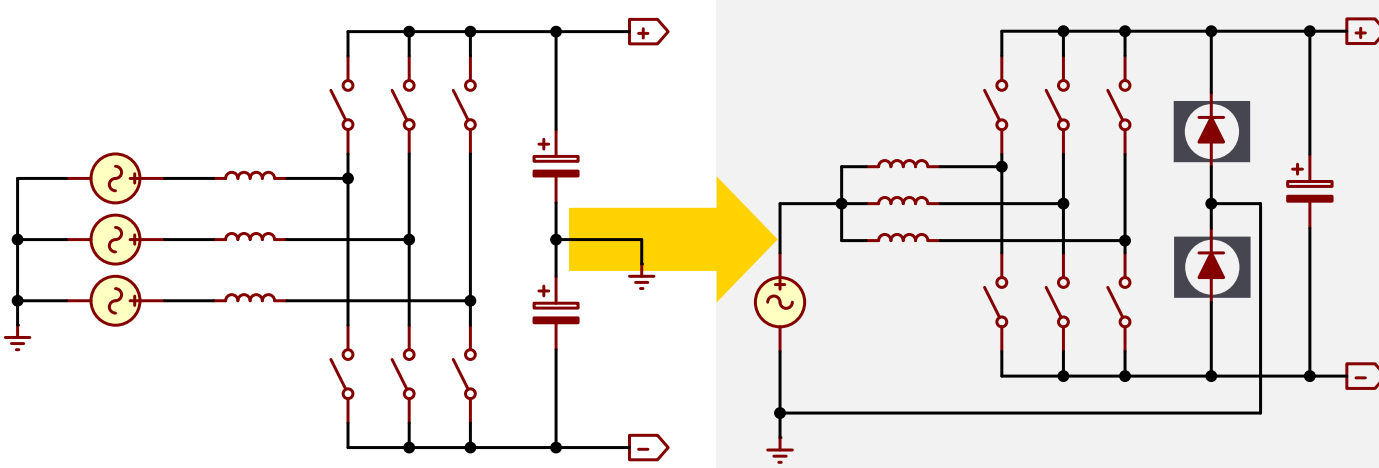


Reverse battery Protection



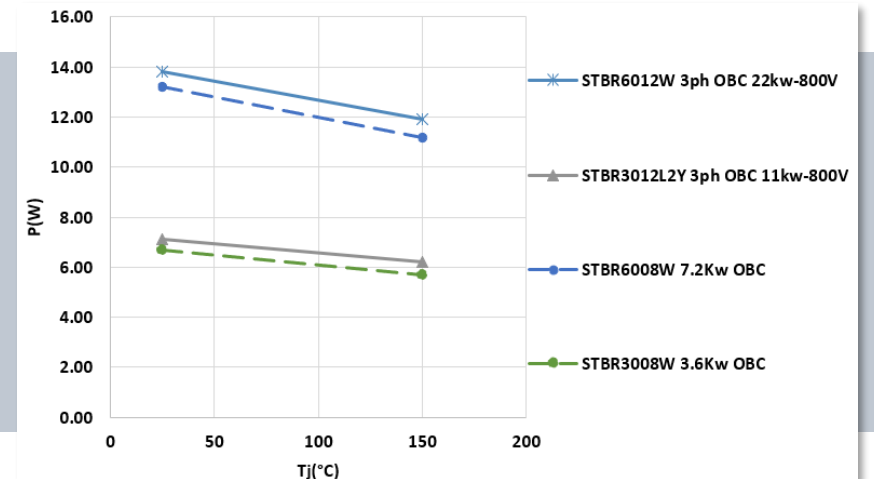
STBR series for low conduction power losses

4 legs allows same power from 3-phase to single-phase

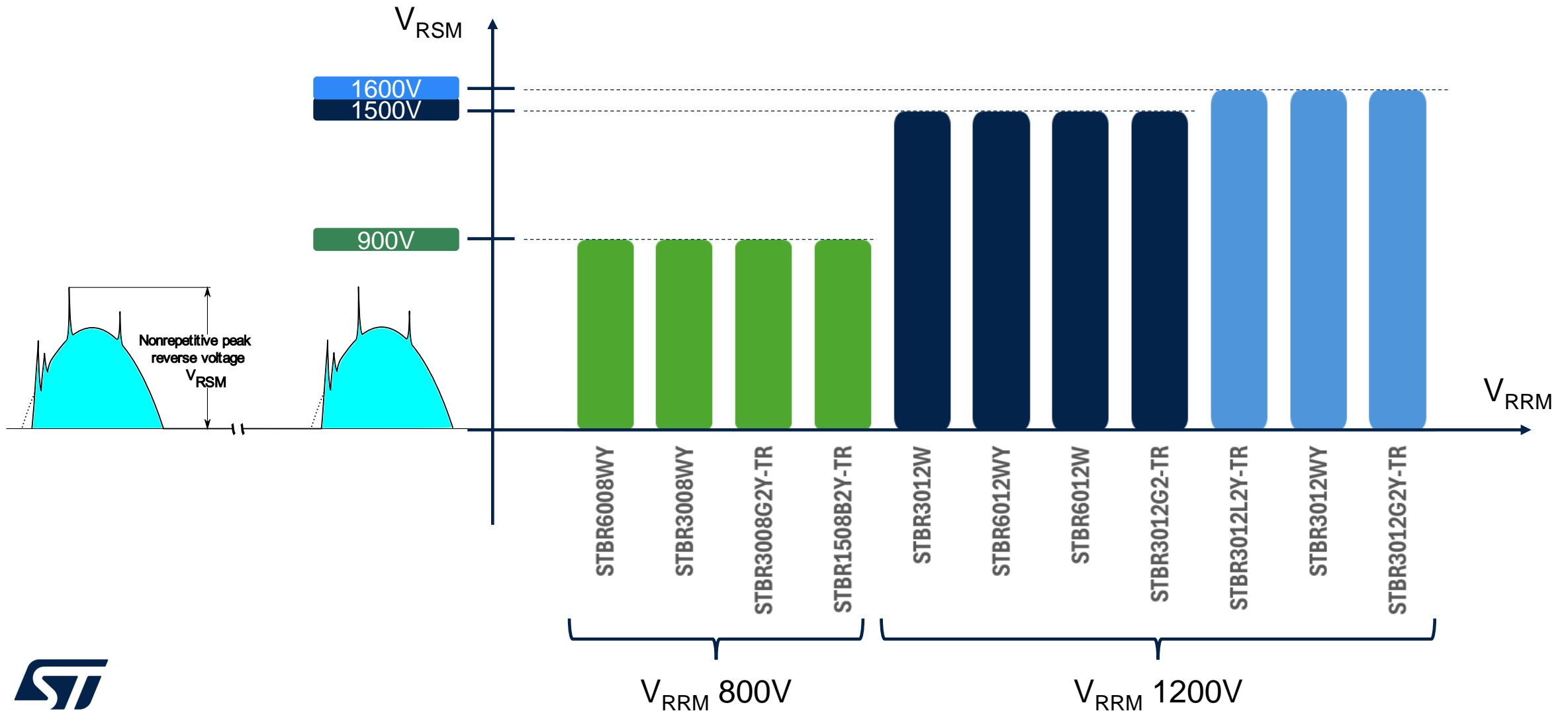


- Easy single phase with four-leg 3-phase PFC
- Less losses than controlled switches
- No gate drivers
- Does not require insulated/floating SMPS
- Save microcontroller ports
- 50 Hz conduction losses reduced
- State-of-the-art and reliable budget solution

Typical conduction losses per diode


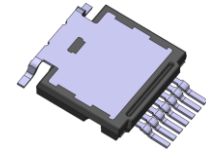






Nonrepetitive reverse voltage guaranteed in datasheet



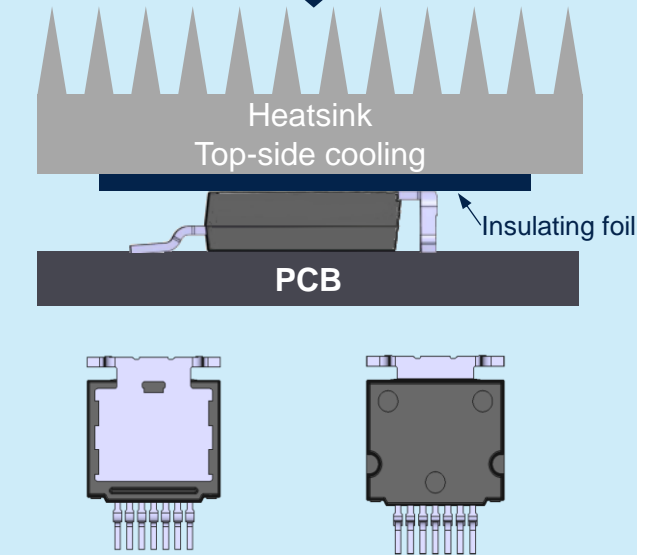
STBR portfolio in mass production

I_{FAV}
60A
15A

Commercial Product (CP)	$I_{F(AVG)}$ (A)	V_{RRM} (V)	cp_base quantity	cp_bulk quantity	Package name	Package picture
STBR3012L2Y-TR 	30	1200	600	600	HU3PAK T.S.C.	
STBR6008WY	60	800	30	600	DO-247	
STBR3008WY	30	800	30	600		
STBR3012WY	30	1200	30	600		
STBR3012W	30	1200	30	600		
STBR6012WY	60	1200	30	600		
STBR6012W	60	1200	30	600		
STBR3008G2Y-TR	30	800	1000	1000	D ² PAK HV	
STBR3012G2Y-TR	30	1200	1000	1000		
STBR3012G2-TR	30	1200	1000	1000		
STBR1508B2Y-TR	15	800	2500	2500	DPAK HV	

Y = Automotive grade 

Top-side cooling allows standard PCBs instead insulated metal substrates



800V

1200V

V_{RRM}

HU3PAK assembly guidelines

Technical note TN1378 provides package mounting and thermal behavior for HU3PAK

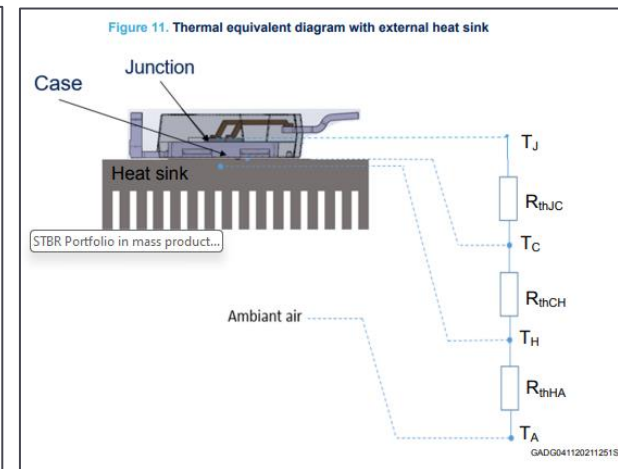
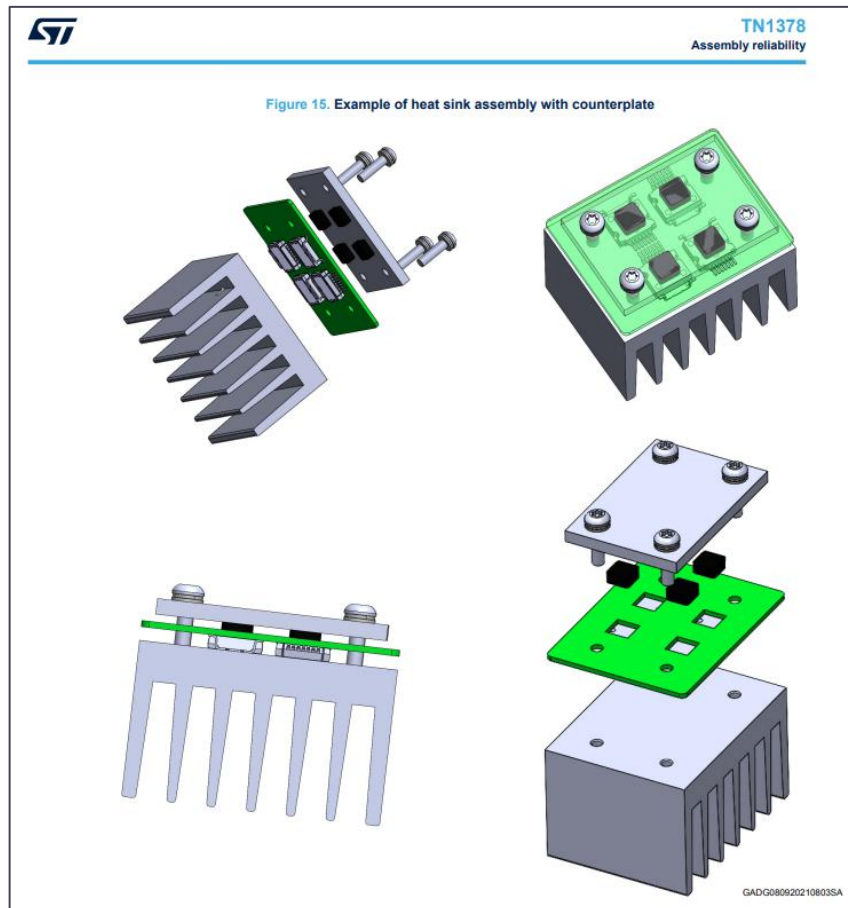
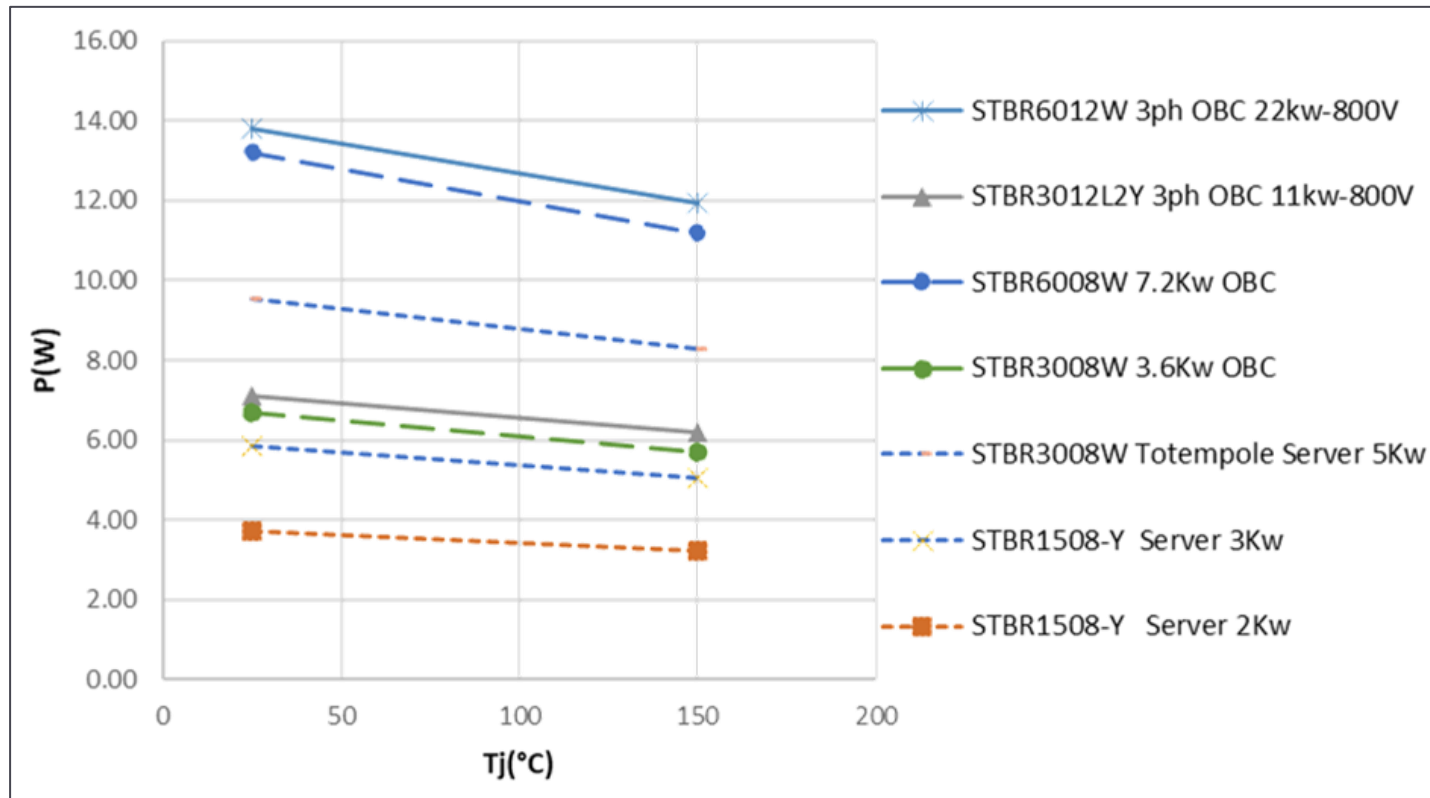


Figure 7. HU3PAK sample mounted on test PCB



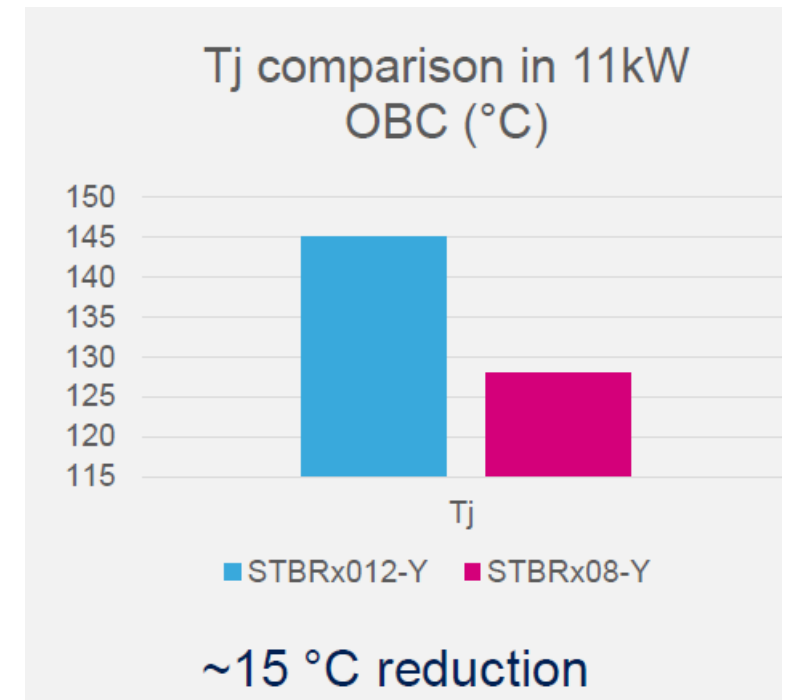
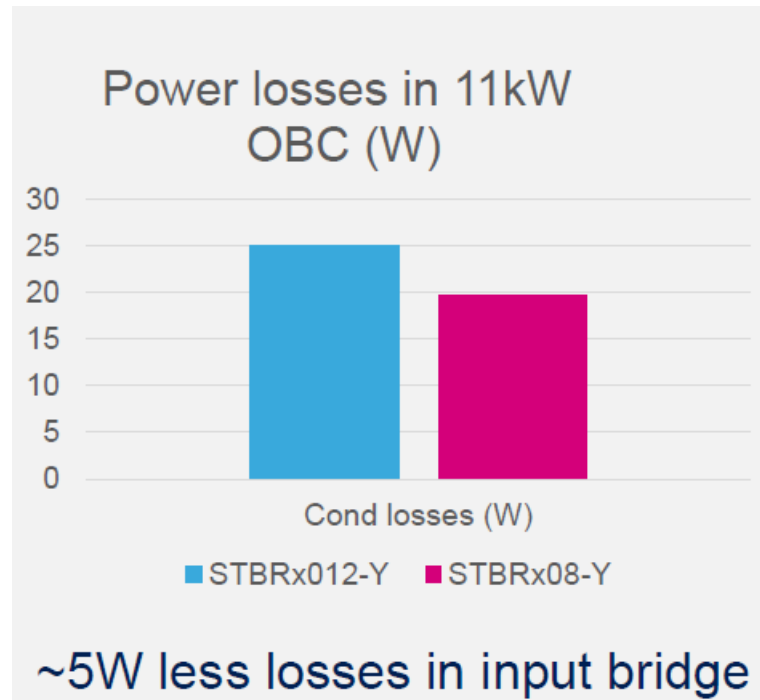
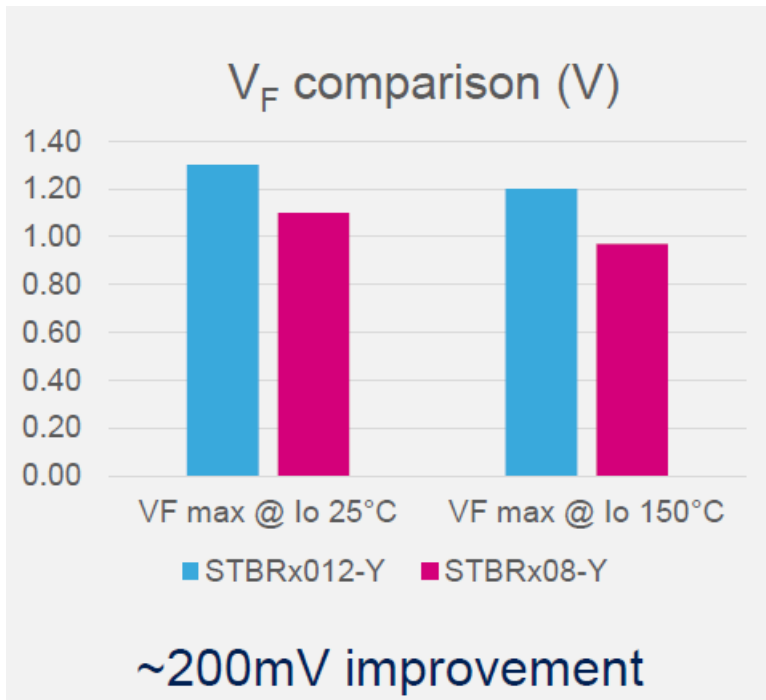
Lower V_F helps reduce conduction losses in low frequency rectification

Typical conduction losses per diode



800 V STBR V_F performance

Lower V_F reduces diode losses and lowers T_j by 15°C in 11 kW OBCs for improved reliability and flexibility in more compact designs

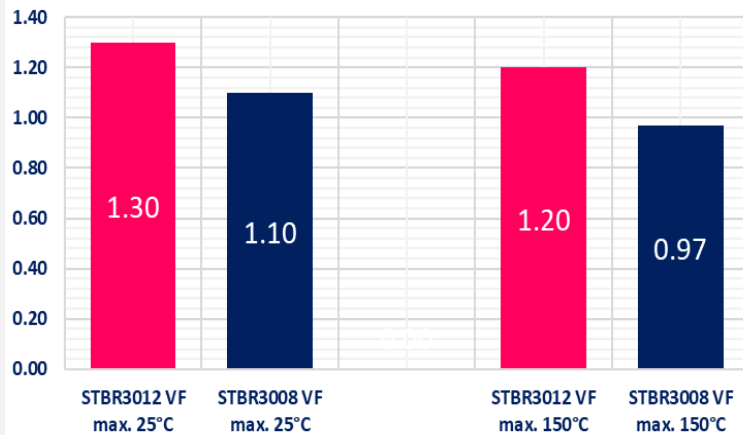


Bridge STBR series V_F performance

Lower V_F reduces diode losses and lowers T_j in 3 kW OBCs for improved reliability and flexibility in more compact designs

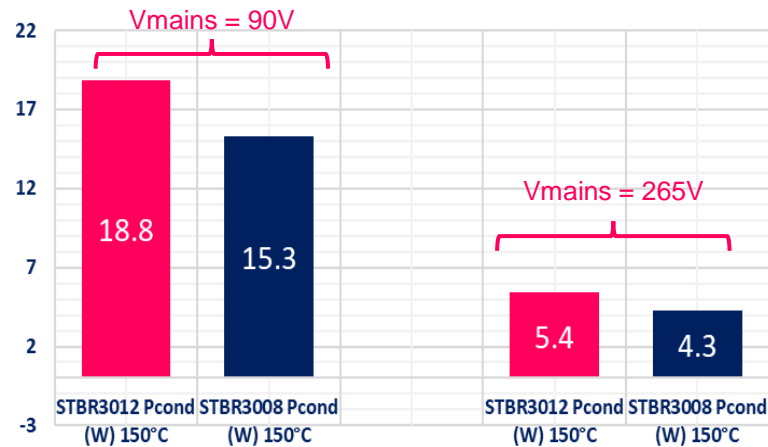
~200mV improvement

V_F (V) comparison at $I_{F0} = 30A$



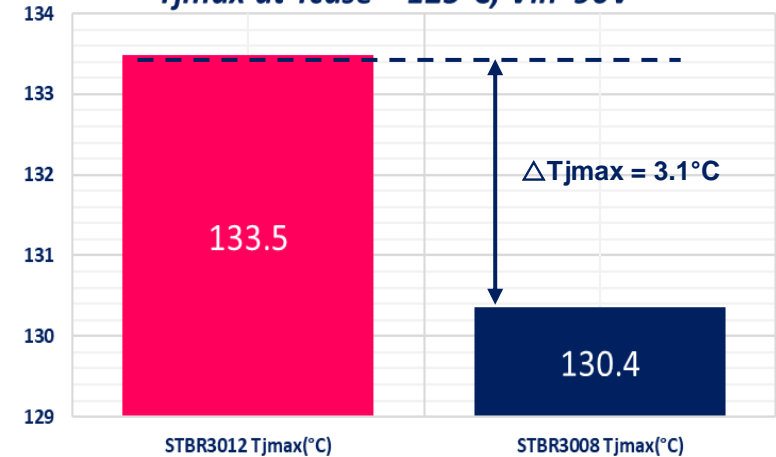
Losses are reduced

Power losses (W) in 3kW Totem pole PFC



Temperature reduction

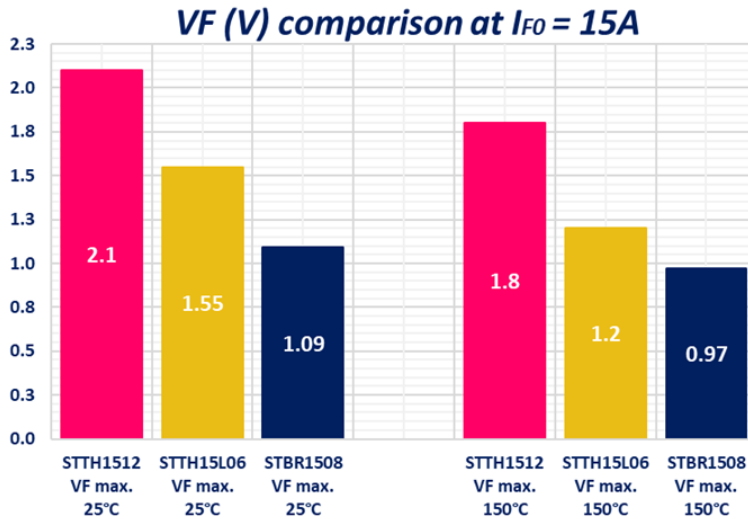
T_{jmax} at $T_{case} = 125^\circ C$, $V_{in} = 90V$



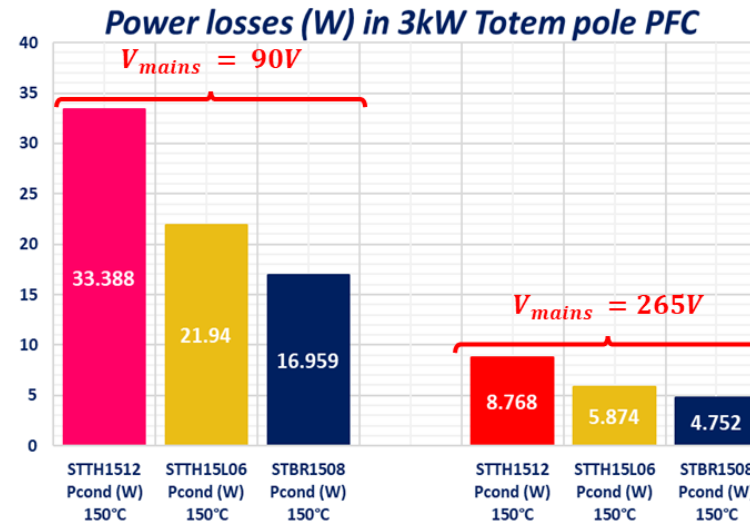
Bridge STBR versus Ultrafast V_F performance

The better VF of STBR1508 reduces diode losses and lowers $\sim 36^\circ\text{C}$ lower T_j than STTH1512D/G and $\sim 29^\circ\text{C}$ than STTH15L06D/G

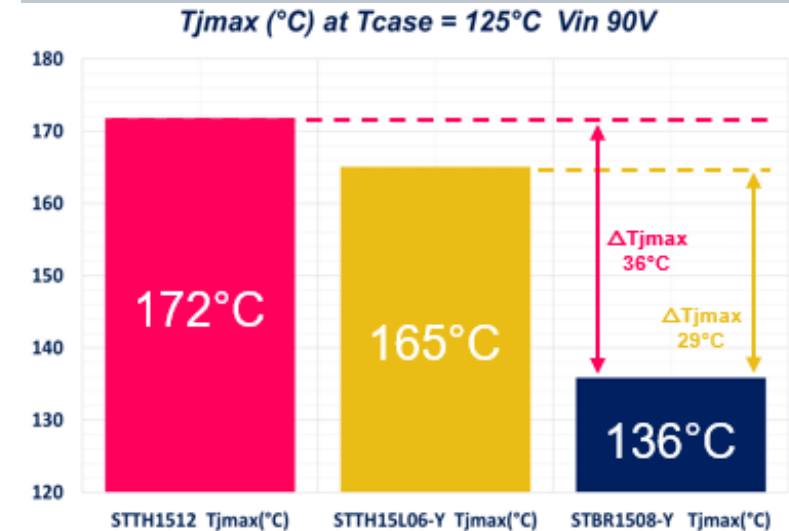
Vf improvement within STBR



Reduced losses in input bridge



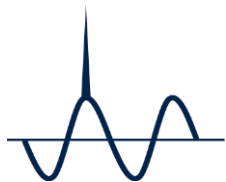
Temp. reduction up to 36°C



Allows use of DPAK instead of D²PAK/TO-220 (surface saving)



Robust and safe automotive-grade STBR



I_{FSM} rated lightning surge capability (IEC61000-4-5)



HV D²PAK, HV DPAK, DO-247, and HU3PAK packages

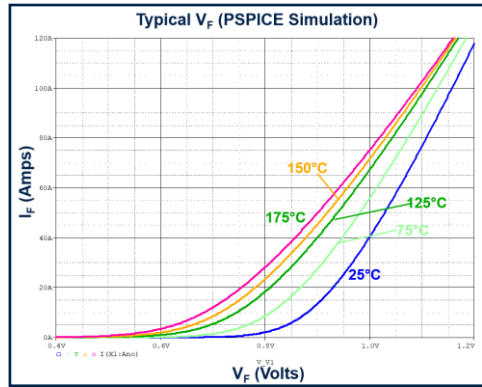


Full V_{RRM} guaranteed (-40 to 175°C) in datasheet

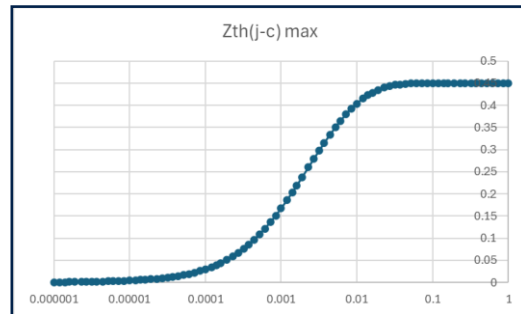
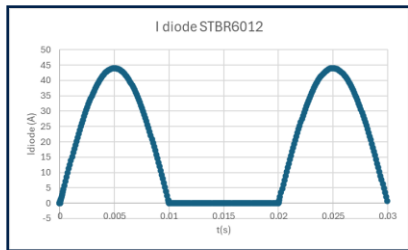
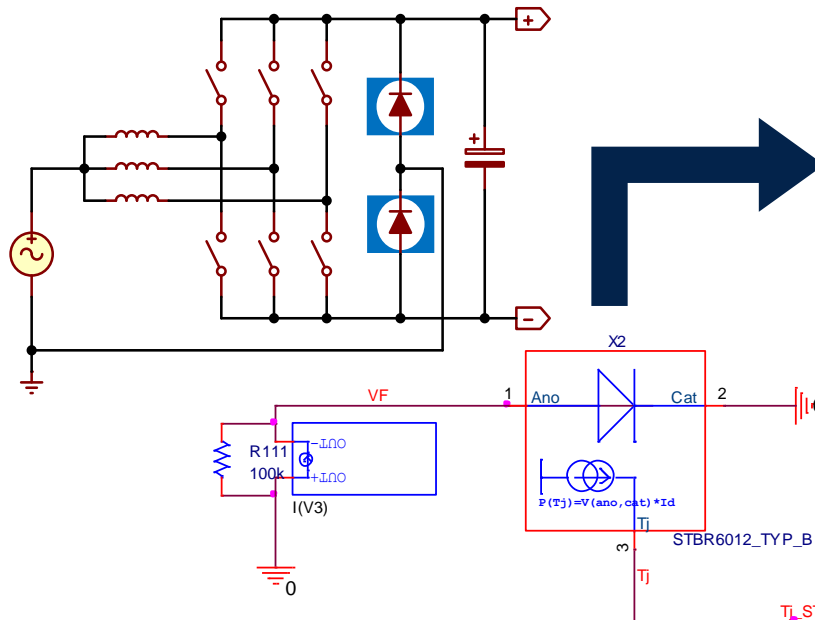


AEC-Q101 qualified – PPAP capable

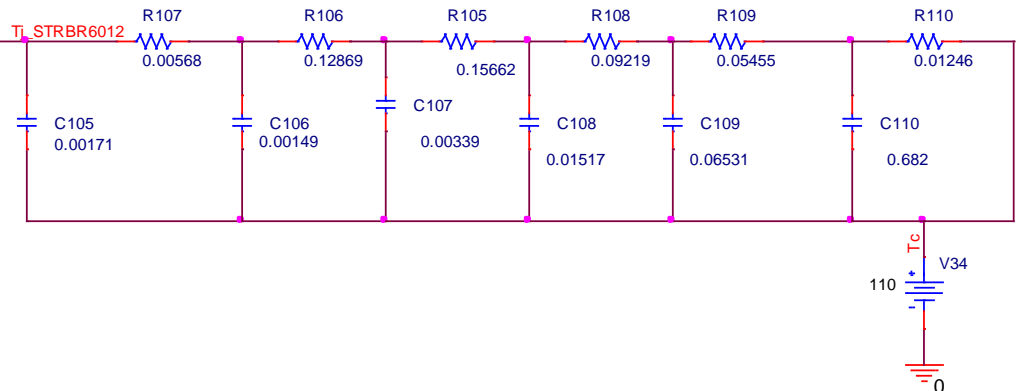
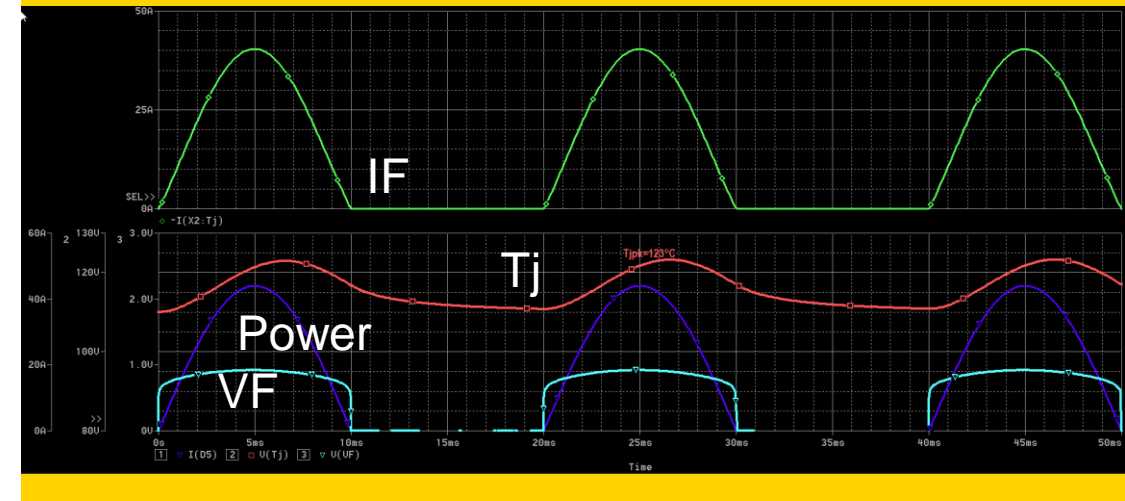
Electrothermal simulation



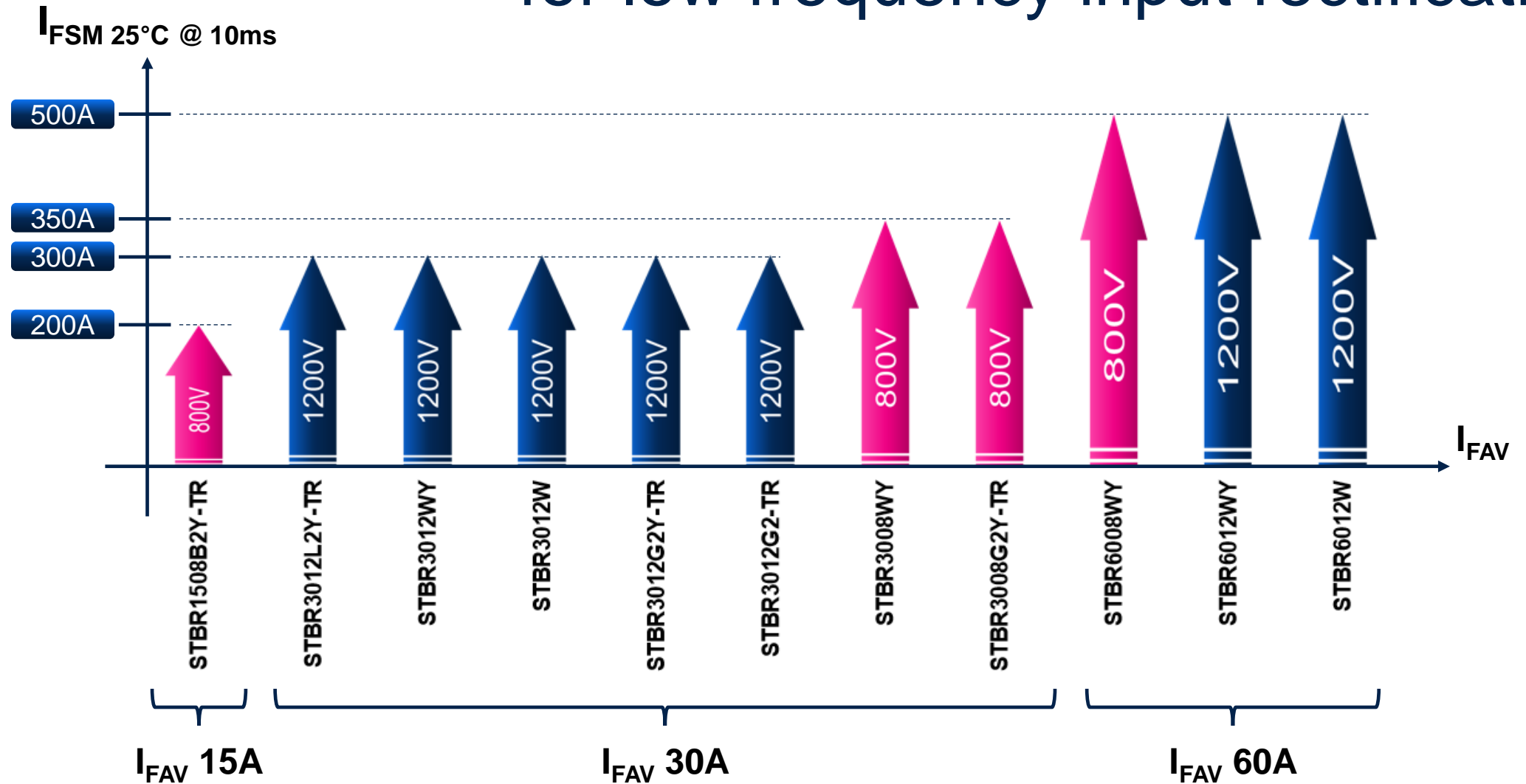
E.g. current waveforms in 22 kW
totem pole low frequency leg



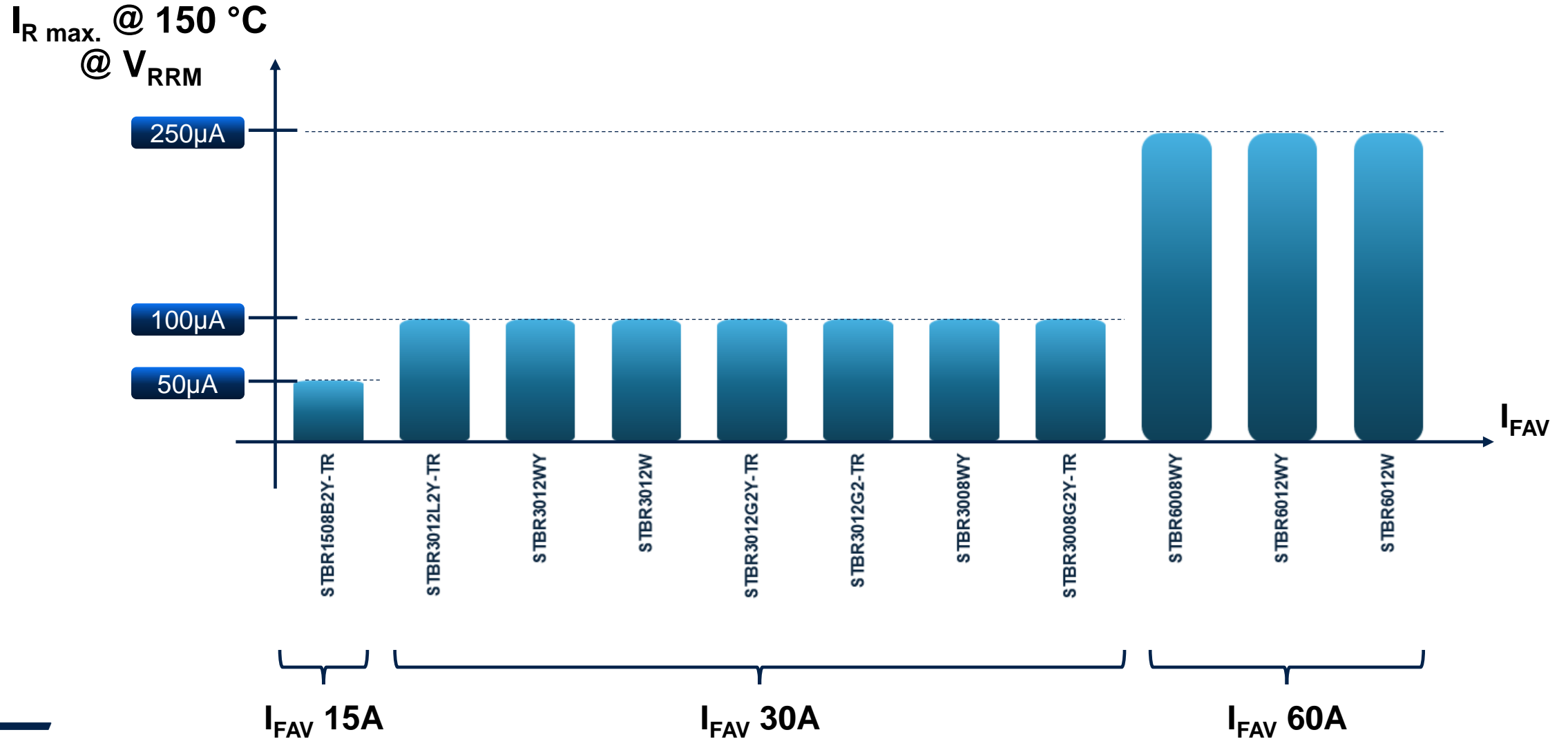
VF(I_F, T_j) SPICE lib file & simulation support
available on demand



STBR allows high surge capability for low frequency input rectification



STBR has lower (I_R) leakage current versus Ultrafast



Summary of STBR features

Reduce thermal stress



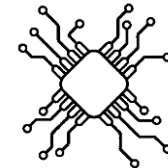
Increase efficiency



Robust & safe



Design support available on request



Our technology starts with You

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